## Amendments to the Claims:

The following listing of claims will replace all prior versions, and listings, of claims in the application:

- 1-7. (Canceled)
- 8. (Currently Amended) A method for producing a single crystal by pulling a single crystal from a raw material melt in a chamber in accordance with Czochralski method, comprising pulling a single crystal having a defect-free region which is outside an OSF region to occur in a ring shape in the radial direction and which and in which interstitial-type and vacancy-type defects do not exist in, exist by controlling a V/G value as indicated by a growth rate (V) and a temperature gradient (G) near a growth interface, wherein the pulling of the single crystal is performed with being controlled so that an average of cooling rate in passing through a temperature region of the melt point of the single crystal to 950 °C is in the range of 0.96 °C/min or more and so that an average of cooling rate in passing through a temperature region of 1150 °C to 1080 °C is in the range of 0.88 °C/min or more and so that an average of cooling rate in passing through a temperature region of 1050 °C to 950 °C is in the range of 0.71 °C/min or more.
- 9. (Currently Amended) The method for producing a single crystal according to Claim 1, claim 8, wherein a growth rate margin for pulling the single crystal having a defect-free region (an upper limit of the growth rate a lower limit of the growth rate) is in the range of 7% or more of a growth rate average of the single crystal ((the upper limit of the growth rate + the lower limit of the growth rate) ÷ 2).
- 10. (Currently Amended) The method for producing a single crystal according to Claim 1, claim 8, wherein the controlling of the temperature region for pulling the single

crystal is performed by arranging at least a cooling cylinder to be forced cooled with a cooling medium and an auxiliary member for cooling in the chamber.

- 11. (Currently Amended) The method for producing a single crystal according to Claim 2, claim 9, wherein the controlling of the temperature region for pulling the single crystal is performed by arranging at least a cooling cylinder to be forced cooled with a cooling medium and an auxiliary member for cooling in the chamber.
- 12. (Currently Amended) The method for producing a single crystal according to Claim 1, claim 8, wherein the single crystal to be produced is a silicon single crystal.
- 13. (Currently Amended) The method for producing a single crystal according to Claim 2, claim 9, wherein the single crystal to be produced is a silicon single crystal.
- 14. (Currently Amended) The method for producing a single crystal according to Claim 3, claim 10, wherein the single crystal to be produced is a silicon single crystal.
- 15. (Currently Amended) The method for producing a single crystal according to Claim 1, claim 8, wherein a diameter of the straight body of the single crystal is 150 mm or more.
- 16. (Currently Amended) The method for producing a single crystal according to Claim 2, claim 9, wherein a diameter of the straight body of the single crystal is 150 mm or more.
- 17. (Currently Amended) The method for producing a single crystal according to Claim 3, claim 10, wherein a diameter of the straight body of the single crystal is 150 mm or more.
- 18. (Currently Amended) The method for producing a single crystal according to Claim 1, claim 8, wherein the pulling of the single crystal is performed with applying a magnetic field of a central magnetic field strength in the range of 300 gauss to 6000 gauss.

- 19. (Currently Amended) The method for producing a single crystal according to Claim 2, claim 9, wherein the pulling of the single crystal is performed with applying a magnetic field of a central magnetic field strength in the range of 300 gauss to 6000 gauss.
- 20. (Currently Amended) The method for producing a single crystal according to Claim 3, claim 10, wherein the pulling of the single crystal is performed with applying a magnetic field of a central magnetic field strength in the range of 300 gauss to 6000 gauss.
- 21. (Currently Amended) A single crystal produced by the method according to Claim 1-claim 8.
- 22. (Currently Amended) A single crystal produced by the method according to Claim 2.claim 9.
- 23. (Currently Amended) A single crystal produced by the method according to Claim 3.claim 10.